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Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>				Complete if Known	
				Application Number	10/763.859
				Filing Date	01/23/2004
				First Named Inventor	TAE HEON LEE
				Art Unit	2811
				Examiner Name	Unknown
				Attorney Docket Number	AMKOR-053G
Sheet	1	of	1		

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FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No.1	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T
		Country Code ³ - Number ⁴ - Kind Code ⁵ (If known)				
pc		100220154	06/18/1999	KOREA		
		10256240	09/25/1998	JAPAN		
		10199934	07/31/1998	JAPAN		
		10163401	06/19/1998	JAPAN		
		EP0844665	05/27/1998	EU PAT. OFFICE		
		10022447	JAN-98	JAPAN		
		9293822	11/11/1997	JAPAN		
		9772358	11/07/1997	KOREA		
		EP0794572A2	10/09/1997	EU PAT. OFFICE		
pc		DE19734794A1	08/11/1997	GERMANY		

Examiner Signature	PHAT X. CAO	Date Considered	6/7/05
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PC		992775	04/04/1997	JAPAN		
		98205	01/10/1997	JAPAN		
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		8306853	11/22/1996	JAPAN		
		8222682	08/30/1996	JAPAN		
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		8083877	03/26/1996	JAPAN		
		864634	03/08/1996	JAPAN		
PC		EP0720225	03/07/1996	EU PAT. OFFICE		

Examiner Signature <u>PHAT X. CAO</u>	Date Considered <u>6/7/05</u>
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PC		EP0720234	03/07/1996	EU PAT. OFFICE		
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		941979	01/03/1994	KOREA		
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PC		63249345	10/17/1988	JAPAN		
		63233555	09/29/1988	JAPAN		
		63205935	08/25/1988	JAPAN		
		63067762	03/26/1988	JAPAN		
		629639	01/17/1987	JAPAN		
		6139555	02/25/1986	JAPAN		
		60231349	11/16/1985	JAPAN		
		60195957	10/04/1985	JAPAN		
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PC		60010756	01/19/1985	JAPAN		

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PC		59227143	12/20/1984	JAPAN		
I		59208756	11/27/1984	JAPAN		
I		EP5950939	03/19/1984	EU PAT. OFFICE		
I		58160095	08/31/1983	JAPAN		
I		5745959	03/16/1982	JAPAN		
I		55163868	12/20/1980	JAPAN		
PC		EP5421117	06/08/1979	EU PAT. OFFICE		

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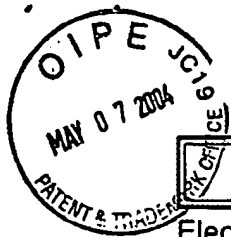
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<p>Application Number: 10/763859</p> <p>Confirmation Number: 8528</p> <p>First Named Applicant: TAE LEE</p> <p>Attorney Docket Number: AMKOR053G</p> <p>Art Unit: 2811</p> <p>Search string: (5886398 or 5894108 or 5897339 or 5900676 or 5903049 or 5903050 or 5909053 or 5915998 or 5917242 or 5939779 or 5942794 or 5951305 or 5959356 or 5969426 or 5973388 or 5976912 or 5977613 or 5977615 or 5977630 or 5981314 or 5986333 or 5986885 or 6001671 or 6013947 or 6018189 or 6020625 or 6025640 or 6031279 or 6034423 or RE36613 or 6040626 or 6043430 or 6060768 or 6060769 or 6072228 or 6075284 or 6081029 or 6084310 or 6087715 or 6087722 or 6100594 or 6114752 or 6113474 or 6118174 or 6118184 or 6130115 or 6130473 or RE36907 or 6133623 or 6140154).pn.</p>							
<p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p>							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
PC	1	5886398	1999-03-23	Low et al.			
	2	5894108	1999-04-13	Mostafazadeh et al.			
	3	5897339	1999-04-27	Song et al.			
	4	5900676	1999-05-04	Kweon et al.			
	5	5903049	1999-05-11	Mori			
	6	5903050	1999-05-11	Thurairajaratnam et al.			
	7	5909053	1999-06-01	Fukase et al.			
	8	5915998	1999-06-29	Stidham et al.			
PC	9	5917242	1999-06-29	Ball			

PC	10	5939779	1999-08-17	Kim
	11	5942794	1999-08-24	Okumura et al.
	12	5951305	1999-09-14	Haba
	13	5959356	1999-09-28	Oh
	14	5969426	1999-10-19	Baba et al.
	15	5973388	1999-10-26	Chew et al.
	16	5976912	1999-11-02	Fukutomi et al.
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	19	5977630	1999-11-02	Woodworth et al.
	20	5981314	1999-11-09	Glenn et al.
	21	5986333	1999-11-16	Nakamura
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	24	6013947	2000-01-11	Lim
	25	6018189	2000-01-25	Mizuno
	26	6020625	2000-02-01	Qin et al.
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	34	6060769	2000-05-09	Wark
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	36	6075284	2000-06-13	Choi et al.
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	41	6100594	2000-08-08	Fukui et al.
	42	6114752	2000-09-05	Huang et al.
	43	6113474	2000-09-05	Costantini et al.
	44	6118174	2000-09-12	Kim
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R	47	6130473	2000-10-10	Mostafazadeh et al.
R	48	RE36907	2000-10-10	Templeton, Jr. et al.
R	49	6133623	2000-10-17	Otsuki et al.
R	50	6140154	2000-10-31	Hinkle et al.

Signature

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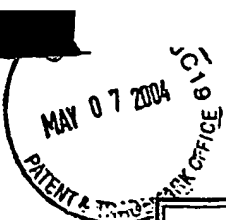
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	24	5736432	1998-04-07	Mackessy
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<p>Application Number: 10/763859</p> <p>Confirmation Number: 8528</p> <p>First Named Applicant: TAE LEE</p> <p>Attorney Docket Number: AMKOR053G</p> <p>Art Unit: 2811</p> <p>Search string: (6348726 or 6355502 or 6369447 or 6369454 or 6373127 or 6380048 or 6384472 or 6388336 or 6395578 or 6410979 or 6400004 or 6414385 or 6420779 or 6429508 or 6437429 or 6444499 or 6448633 or 6452279 or 6459148 or 6464121 or 6476469 or 6476474 or 6482680 or 6498099 or 6498392 or 6507096 or 6507120 or 6534849 or 6545332 or 6545345 or 6559525 or 6566168 or 6583503 or 6667546),pn.</p> <p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td><input checked="" type="checkbox"/></td><td>1</td><td>6348726</td><td>2002-02-19</td><td>Bayan et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>2</td><td>6355502</td><td>2002-03-12</td><td>Kang et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>3</td><td>6369447</td><td>2002-04-09</td><td>Mori</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>4</td><td>6369454</td><td>2002-04-09</td><td>Chung</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>5</td><td>6373127</td><td>2002-04-16</td><td>Baudouin et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>6</td><td>6380048</td><td>2002-04-30</td><td>Boon et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>7</td><td>6384472</td><td>2002-05-07</td><td>Huang</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>8</td><td>6388336</td><td>2002-05-14</td><td>Venkateshwaran et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>9</td><td>6395578</td><td>2002-05-28</td><td>Shin et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>10</td><td>6410979</td><td>2002-06-02</td><td>Abe</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>11</td><td>6400004</td><td>2002-06-04</td><td>Fan et al.</td><td></td><td></td><td></td></tr><tr><td><input checked="" type="checkbox"/></td><td>12</td><td>6414385</td><td>2002-07-02</td><td>Huang et al.</td><td></td><td></td><td></td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	<input checked="" type="checkbox"/>	1	6348726	2002-02-19	Bayan et al.				<input type="checkbox"/>	2	6355502	2002-03-12	Kang et al.				<input type="checkbox"/>	3	6369447	2002-04-09	Mori				<input type="checkbox"/>	4	6369454	2002-04-09	Chung				<input type="checkbox"/>	5	6373127	2002-04-16	Baudouin et al.				<input type="checkbox"/>	6	6380048	2002-04-30	Boon et al.				<input type="checkbox"/>	7	6384472	2002-05-07	Huang				<input type="checkbox"/>	8	6388336	2002-05-14	Venkateshwaran et al.				<input type="checkbox"/>	9	6395578	2002-05-28	Shin et al.				<input type="checkbox"/>	10	6410979	2002-06-02	Abe				<input type="checkbox"/>	11	6400004	2002-06-04	Fan et al.				<input checked="" type="checkbox"/>	12	6414385	2002-07-02	Huang et al.			
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Signature

Examiner Name	Date
PHAT Y. CAO	6/7/05